PCN Number:		20221020002.1					PCN Date:		October 21, 2022	
Title:	Qualifica	tion of CD	AT as an alterna	ate	Assembly site for s	ele	ect devi	ces		
Custom	Customer Contact: PCN Manager Dept: Quality Services									
Proposed 1 st Ship		p Date:	Jan 19, 2023	Sample		Rec	anuests		21, 2022*	
*Sampl	e reques	ts receive	d after Nov 21,	20	22 will not be sup	po	rted.	•		
Change	Type:									
⊠ Ass	embly Site	9	Desi	esign			Wafe	Vafer Bump Site		
Ass	embly Pro	cess	☐ Data	a Sheet			Wafe	Wafer Bump Material		
Ass	embly Mat	erials	☐ Part	Part number change			Wafe	Vafer Bump Process		
☐ Med	hanical S	pecificatio	n 🔲 Test	t Si	te			Wafer Fab Site		
Pac	king/Shipp	oing/Labelii	ng 🔲 Test	est Process			Wafe	Wafer Fab Materials		
							Wafer Fab Prod		Process	
			P	CN	Details					
Descrip	tion of Cl	nange:								
Texas Instruments Incorporated is announcing the qualification of CDAT as an additional Assembly site for set of devices listed below. There are no construction differences between the two sites										
Reason	for Chan	ge:								
Supply o	ontinuity									
Anticipa	ated impa	act on For	m, Fit, Functio	n,	Quality or Reliabili	ty	(positi	ve / n	egative):	
None										
Impact	on Envir	onmental	Ratings							
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.										
RoHS			REACH	Green Status		us	s IE		C 62474	
⊠ No (Change		☑ No Change		☑ No Change		\boxtimes	No Cl	nange	
	<u> </u>									
Change	Changes to product identification resulting from this PCN:									
Assembly Site		Assem	Assembly Site Origin (22L)		Assembly Country Code (23L)			Assembly City		
TI	Clark		QAB		PHL		Ar	Angeles City, Pampanga		
CDAT		CDA			CHN			Chengdu		
Texas										

Product Affected:					
	SN2001088YBGR	TMP117AIYBGR	TMP117MAIYBGR	TMP117NAIYBGR	
	TEXAS INSTRUMENTS			TI Information Selective Disclosure	

Qualification Results Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: <u>TMP117AIYBG</u>	QBS Product Reference: TMP117AIDRV
HTOL	Life Test, 150C	300 Hours	-	3/231/0
HAST	Biased HAST, 130C/85%RH	96 Hours	3/231/0	-
UHAST	Unbiased HAST 130C/85%RH	96 Hours	3/231/0	-
тс	Temperature Cycle, -40/125C	850 Cycles	3/231/0	-
HTSL	High Temp Storage Bake 170C	420 Hours	3/231/0	-
нвм	ESD - HBM	4000 V	1/3/0	1/3/0
СДМ	ESD - CDM	1500 V	1/3/0	-
LU	Latch-up	(per JESD78)	1/6/0	1/6/0
ED	Electrical Characterization	Per Datasheet Parameters	1/30/0	1/30/0

⁻ Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

Note: Approved conditionally pending completion of TMCL (850 cycles).

- The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status: Qualified Pb-Free(SMT) and Green

TI Qualification ID: 20180502-125693

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail			
WW Change Management Team	PCN www admin_team@list.ti.com			

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